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Designed for: Public Release		Mod. Date: 4/29/2015	
Project Title: PMP9382 LM3478 Low Vin Boost		Sheet Title:	
Number: PMP9382	Rev: 2	Assembly Variant: 001	Sheet: 1 of 2
SVN Rev: Version control disabled		File: PMP9382 schematic rev2.SchDoc	Size: B
Drawn By:		Contact: http://www.ti.com/support	
Engineer: D Baba			



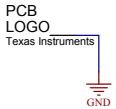
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1 2 3 4 5 6

A

A

PCB Number: PMP9382
PCB Rev: A



LBL1
PCB Label
Size: 0.65" x 0.20"

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

D

D

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Drawn By:	Engineer: D Baba	File: PMP9382_Hardware_ANSI-B_SchDoc	Sheet: 2 of 2	Size: B
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